



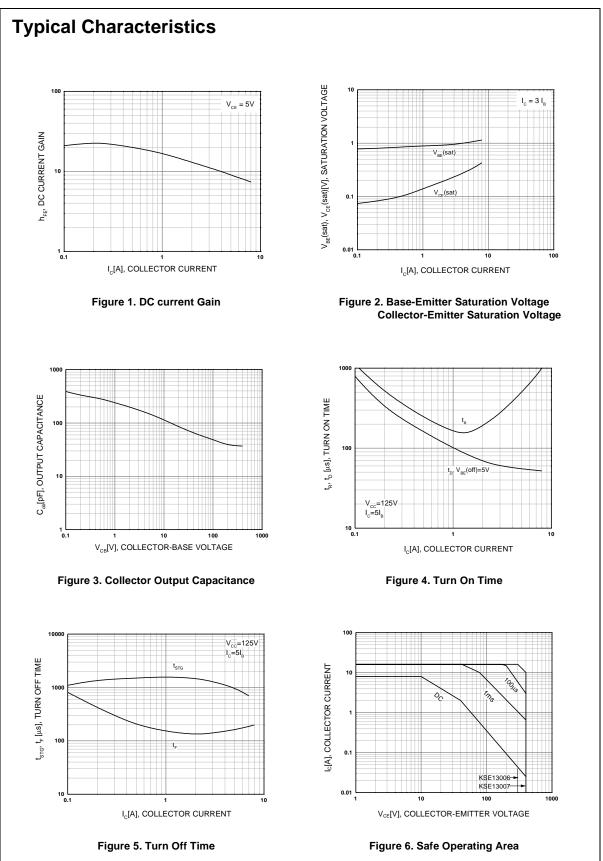
NPN Silicon Transistor

Symbol	Parameter		Value	Units
V _{CBO}	Collector-Base Voltage	: KSE13006	600	V
	ED , 250.00	: KSE13007	700	V
V _{CEO}	Collector-Emitter Voltage	: KSE13006	300	V
		: KSE13007	400	V
V _{EBO}	Emitter- Base Voltage		9	V
I _C	Collector Current (DC)		8	А
I _{CP}	Collector Current (Pulse)		16	А
I _B	Base Current		4	A
P _C T _J	Collector Dissipation (T _C =25°C)		80	W
TJ	Junction Temperature		150	°C
T _{STG}	Storage Temperature	5 M/6	- 65 ~ 150	°C

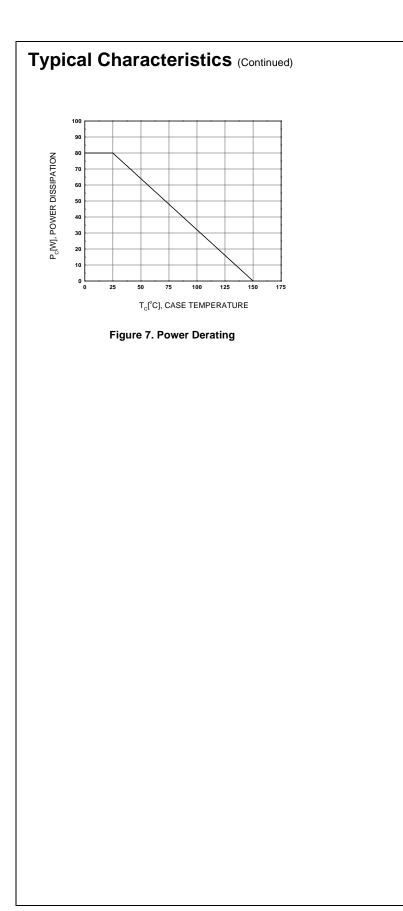
Electrical Characteristics T_C=25°C unless otherwise noted

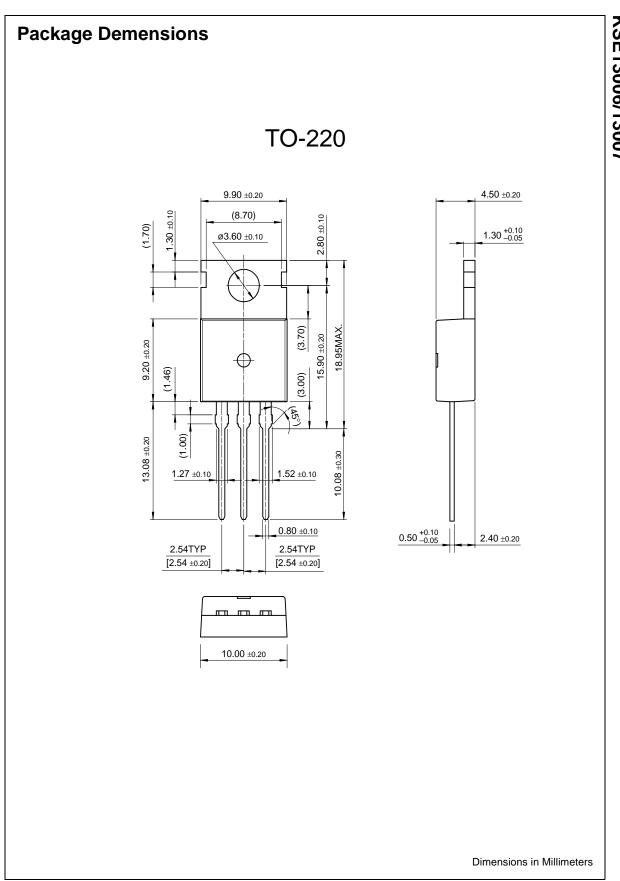
Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV _{CEO}	Collector- Emitter Breakdown Voltage : KSE13006 : KSE13007	I _C = 10mA, I _B = 0	300 400			V V
I _{ЕВО}	Emitter Cut-off Current $V_{EB} = 9V, I_C =$				1	mA
h _{FE}	*DC Current Gain	$V_{CE} = 5V, I_C = 2A$ $V_{CE} = 5V, I_C = 5A$	8 5	27	60 30	C.C.
V _{CE} (sat)	*Collector-Emitter Saturation Voltage	$I_{C} = 2A, I_{B} = 0.4A$ $I_{C} = 5A, I_{B} = 1A$ $I_{C} = 8A, I_{B} = 2A$		N	1 2 3	V V V
V _{BE} (sat)	*Base-Emitter Saturation Voltage	$I_{C} = 2A, I_{B} = 0.4A$ $I_{C} = 5A, I_{B} = 1A$			1.2 1.6	V V
C _{ob}	Output Capacitance	V _{CB} = 10V, f = 0.1MHz		110		pF
f _T	Current Gain Bandwidth Product	V _{CE} = 10V, I _C = 0.5A	4			MHz
ton	Turn On Time	V _{CC} = 125V, I _C = 5A	1		1.6	μs
t _{STG}	Storage Time	$I_{B1} = -I_{B2} = 1A$			3	μs
t _F	Fall Time	$R_{L} = 50\Omega$			0.7	μs

Contractional Semiconductor International



KSE13006/13007





KSE13006/13007

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx[™] Bottomless[™] CoolFET[™] CROSSVOLT[™] E²CMOS[™] FACT[™] FACT Quiet Series[™] FAST[®] FAST[®] FAST[®] GTO[™] HiSeC[™] ISOPLANAR[™] MICROWIRE[™] POP[™] PowerTrench[®] QFET[™] QS[™] Quiet Series[™] SuperSOT[™]-3 SuperSOT[™]-6 SuperSOT[™]-8 SyncFET[™] TinyLogic[™] UHC[™] VCX[™]

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR INTERNATIONAL.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.